502568006 11/13/2013

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2613827

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KOICHI TOBA	08/15/2013
HIRAKU CHAKIHARA	08/27/2013
YOSHIYUKI KAWASHIMA	08/27/2013
KENTARO SAITO	08/27/2013
TAKASHI HASHIMOTO	08/27/2013

RECEIVING PARTY DATA

Name:	RENESAS ELECTRONICS CORPORATION	
Street Address:	1753, SHIMONUMABE, NAKAHARA-KU	
Internal Address:	KAWASAKI-SHI	
City:	KANAGAWA	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14079120	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	8123-1224
NAME OF SUBMITTER:	ERIC JENSEN
	TATENT

502568006 REEL: 031594 FRAME: 0854

OP \$40,00 14079120

Signature:	/Eric Jensen/
Date:	11/13/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 4 source=ASSMT#page1.tif source=ASSMT#page2.tif source=ASSMT#page3.tif source=ASSMT#page4.tif	

PATENT REEL: 031594 FRAME: 0855

Docket No.: Only After Sept 16, 2012

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 OFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

consideration all papers deemed neces the assignee.	sary by	the assignee in connection with the united states application when called upon to do so by
(Legalization not required for recording	but is	prima facie evidence of execution under 35 USC 261)
As the below named inventor, I hereby	declare	e that:
This assignment with declaration is directed to:	X	The attached application, or
	X	United States Application or PCT International Application Number 14/079,120
		filed on November 13, 2013
The application is entitled:		
	METHO	DD OF MANUFACTURING SEMICONDUCTOR DEVICE
The above identified application was m	ade or	was authorized to be made by me.
I believe that I am the original inventor	orano	original joint inventor of a claimed invention in the application.
I have reviewed and understand the co	ontents	of the application for which this assignment with declaration is being submitted.
I am aware of the duty to disclose to t	he Offic	ce all information known to me to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful for imprisonment of not more than five		tement made in this assignment with declaration is punishable under 18 USC 1001 by fine rs, or both.
Authorization To Permit Access To A	Applicat	ion by Participating Office
(JPO), the Korean Intellectual Property property offices in which a foreign app patent application. See 37 CFR 1.14(c)	y Office lication and (h	s the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual claiming priority to the above-identified application is filed access to the above-identified). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or reign application claiming priority to the above-identified application is filed to have
identified patent application-as-filed, 2 119(a)-(d) if a copy of the foreign appl	2) any fo ication	will be provided to a copy of the application—as—filed with respect to: 1) the above—oreign application to which the above—identified application claims priority under 35 USC that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above—upplication—as—filed from which benefit is sought in the above—identified patent application.

PATENT REEL: 031594 FRAME: 0856

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit

Access to Application by Participating Office.

Legal Name of Inventor	Koichi TOBA			
Inventor's Signature	Koich	: Tobal	Date Augus	15,2013
Legal Name of Additional Inv	ventor, If Any	Hiraku CHAKIHARA		
Inventor's Signature			Date	***************************************
Legal Name of Additional Inv	ventor, If Any	Yoshiyuki KAWASHIMA		
Inventor's Signature			Date	
Legal Name of Additional Inv	ventor, If Any	Kentaro SAITO		
Inventor's Signature	·····		Date	
Legal Name of Additional Inv	ventor, If Any	Takashi HASHIMOTO		
Inventor's Signature			Date	

Docket No.: Only After Sept 16, 2012

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of Kanagawa, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261) As the below named inventor, I hereby declare that: This assignment with declaration is The attached application, or directed to: United States Application or PCT International Application Number 14/079,120 filed on November 13, 2013 The application is entitled: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE The above identified application was made or was authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted. I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56. I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both. Authorization To Permit Access To Application by Participating Office If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application. In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the aboveidentified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the aboveidentified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application. In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit

Access to Application by Participating Office.

Legal Name of Inventor	Koichi TOBA		
Inventor's Signature	·		Date
Legal Name of Additional	Inventor, If Any	Hiraku CHAKIHARA	
Inventor's Signature	Junile 1	<u>Chilchera</u>	Date August 27, 2013
Legal Name of Additional	Inventor, If Any	Yoshiyuki KAWASHIMA	
Inventor's Signature	<u>Yoshiyu E</u>	i Kawashima	Date <u>August 27,203</u>
Legal Name of Additional	Inventor, If Any	Kentaro SAITO	
Inventor's Signature	Kentoro	Soite	Date <u>August</u> 27, 20/3
Legal Name of Additional	Inventor, If Any	Takashi HASHIMOTO	
Inventor's Signature	Takashi	Hadrimoto	Date August 27. 2013

PATENT REEL: 031594 FRAME: 0859

RECORDED: 11/13/2013